

2A, 400V - 600V ESD Capability Rectifier

FEATURES

- High ESD capability
- Glass passivated chip junction
- Low forward voltage drop
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

- General purpose
- Polarity protection

MECHANICAL DATA

- Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.030g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	2	A
V_{RRM}	400 - 600	V
I_{FSM}	40	A
$T_J \text{ MAX}$	175	°C
Package	Thin SMA	
Configuration	Single die	


**HALOGEN
FREE**


Thin SMA



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER		SYMBOL	TSD2GAL	TSD2JAL	UNIT
Marking code on the device			D2GAL	D2JAL	
Repetitive peak reverse voltage		V _{RRM}	400	600	V
Reverse voltage, total rms value		V _{R(RMS)}	280	420	V
Forward current		I _F	2		A
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms	I _{FSM}	40		A
	t = 1.0ms		130		
Junction temperature		T _J	-40 to +175		°C
Storage temperature		T _{STG}	-55 to +175		°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	15	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	75	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	15	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 1\text{A}, T_J = 25^\circ\text{C}$	V_F	0.89	-	V
	$I_F = 2\text{A}, T_J = 25^\circ\text{C}$		0.94	1.1	V
	$I_F = 1\text{A}, T_J = 125^\circ\text{C}$		0.77	-	V
	$I_F = 2\text{A}, T_J = 125^\circ\text{C}$		0.83	-	V
Reverse current @ rated V_R ⁽²⁾	$T_J = 25^\circ\text{C}$	I_R	-	1	μA
	$T_J = 125^\circ\text{C}$		5	-	μA
Junction capacitance	1MHz, $V_R = 4.0\text{V}$	C_J	15	-	pF

Notes:

- Pulse test with $PW = 0.3\text{ms}$
- Pulse test with $PW = 30\text{ms}$

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING
STANDARDS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body mode	$C=100\text{pF}, R=1.5\text{k}\Omega$	V_c	H3B	$\geq 8\text{kV}$
IEC 61000-4-2	Contact mode	$C=150\text{pF}, R=330\Omega$		x	$\geq 10\text{kV}$
	Air-discharge mode	$C=150\text{pF}, R=330\Omega$		4	$\geq 15\text{kV}$

ORDERING INFORMATION

ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
TSD2xAL	Thin SMA	14,000/ Tape & Reel

Notes:

- "x" defines voltage from 400V(TSD2GAL) to 600V(TSD2JAL)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

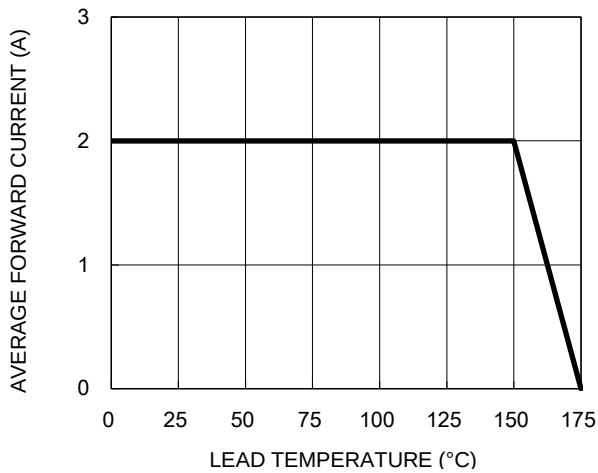


Fig.2 Typical Junction Capacitance

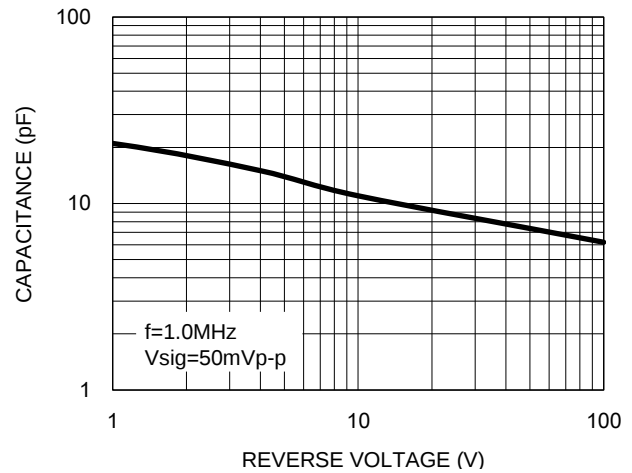


Fig.3 Typical Reverse Characteristics

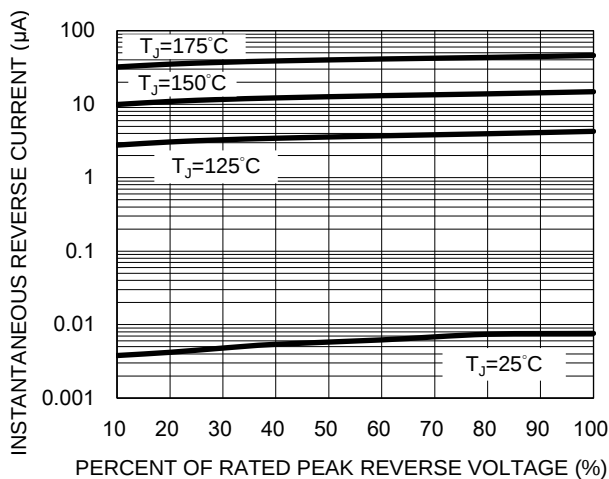


Fig.4 Typical Forward Characteristics

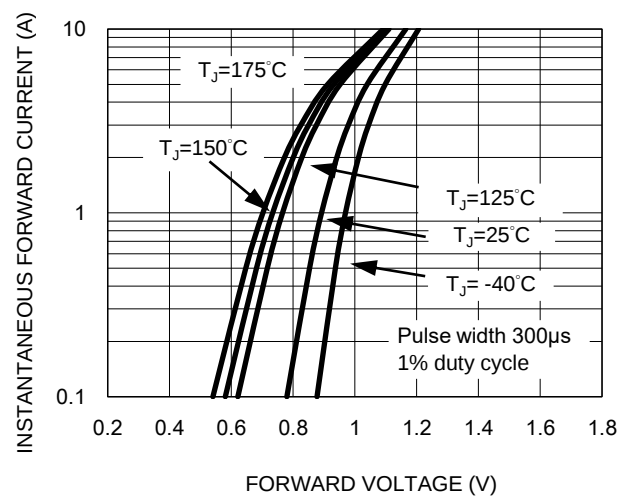
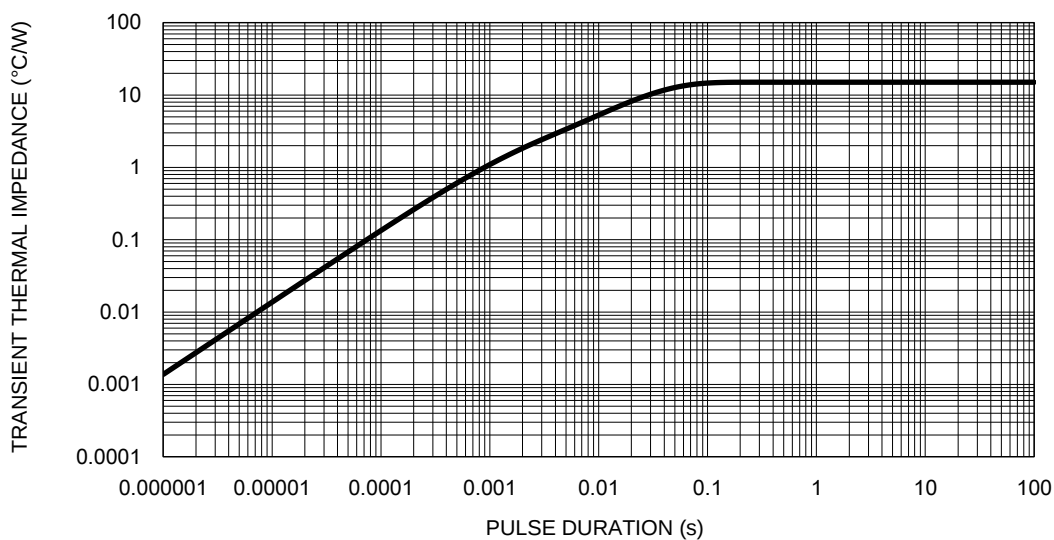
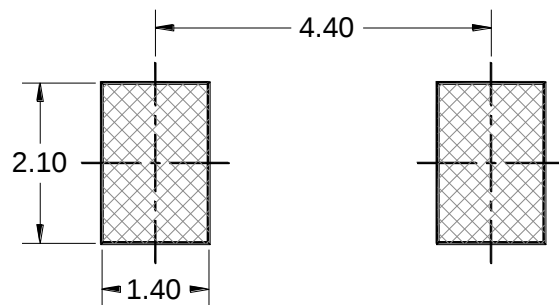
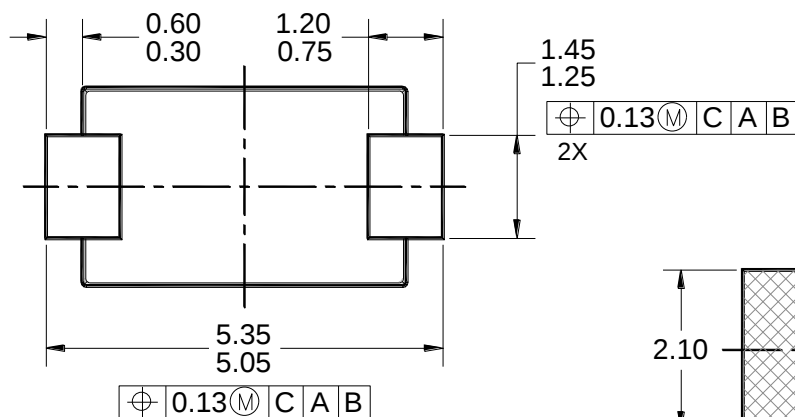
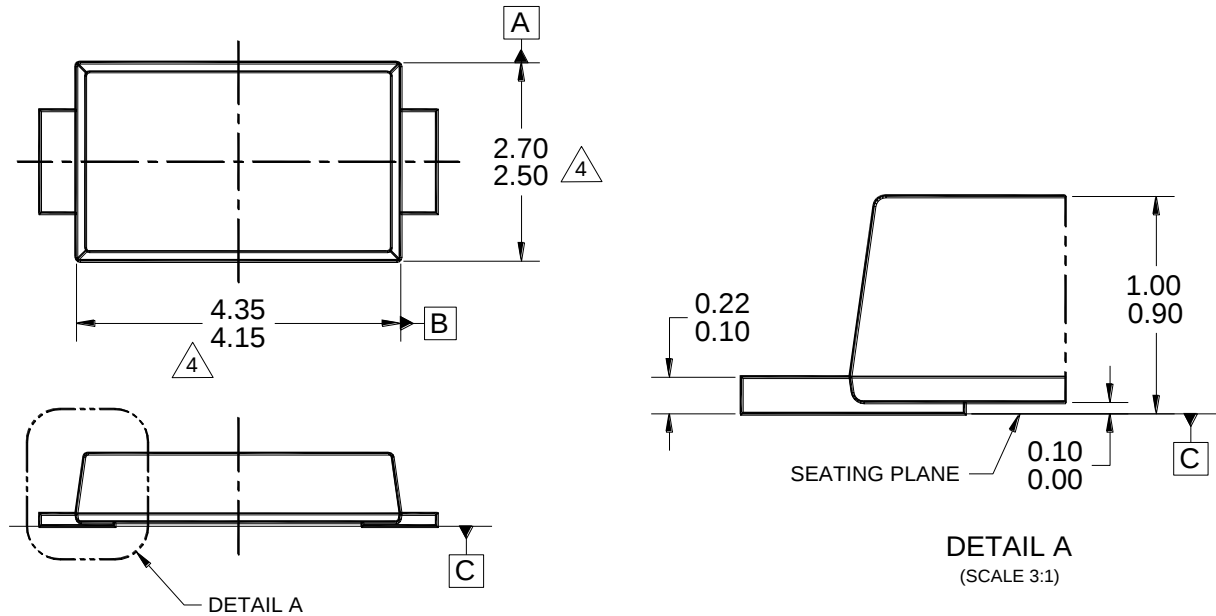


Fig.5 Typical Transient Thermal Impedance

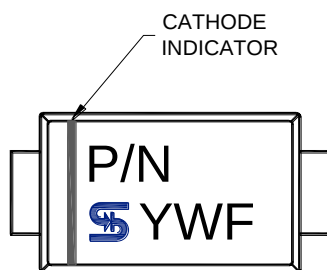


PACKAGE OUTLINE DIMENSIONS

Thin SMA



SUGGESTED PAD LAYOUT



MARKING DIAGRAM

P/N = MARKING CODE
YW = DATE CODE
F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
3. PACKAGE OUTLINE REFERENCE:
JEDEC DO-221, VARIATION AC, ISSUE B.
4. MODED PLASTIC BODY DIMENSIONS DO NOT
INCLUDE MOLD FLASH.
5. SUGGESTED PAD LAYOUT IS FOR REFERENCE
PURPOSE ONLY.
6. DWG NO. REF: HQ2SD07-TSMA-074 REV A.

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